19-1544; Rev 2; 09/07

USB Current-Limited Switch in Pin-Compatible Package

General Description

The MAX1607 is a current-limited 60mΩ switch with built-in fault blanking. Its accurate, preset 0.7A to 1.0A current limit makes it ideal for USB applications. Its low quiescent supply current (14µA) and standby current (1µA) conserve battery power in portable applications. The MAX1607 operates with inputs from +2.7V to +5.5V, making it ideal for both 3V and 5V systems.

An overcurrent signal ($\overline{OC}$) notifies the microprocessor that the internal current limit has been reached. A 10ms overcurrent-blanking feature allows momentary faults (such as those caused when hot-swapping into a capacitive load) to be ignored, thus preventing false alarms to the host system. This blanking also prevents an $\overline{OC}$ signal from being issued when the device is powering up.

The MAX1607 has several safety features to ensure that the USB port is protected. Built-in thermal-overload protection limits power dissipation and junction temperature. The device also has accurate internal current-limiting circuitry to protect the input supply against overload.

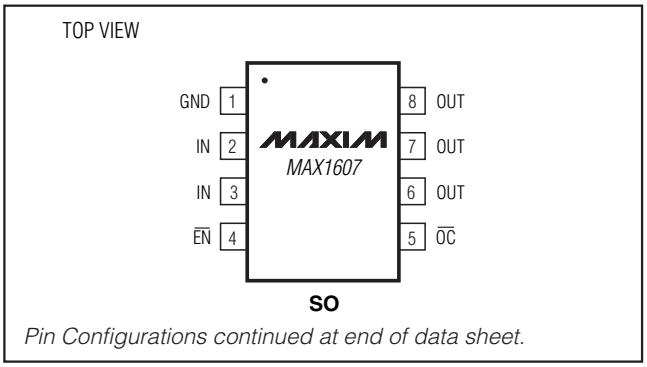
The MAX1607 is a pin-compatible upgrade to Texas Instruments' TPS2014, TPS2015, and TPS2041 for USB applications. The same die is available in a space-saving 10-pin µMAX® package (MAX1693) and can be used for next-generation designs. The MAX1694 is similar to the MAX1693, but it has a built-in latch that turns off the power switch in case of a long-term short-circuit condition.

The MAX1607 is also offered in a 10-pin TDFN package (not pin compatible with Texas Instruments TPS2014, TPS2015, and TPS2041 for USB applications).

Applications

Notebook Computers
USB Ports
USB Hubs
Docking Stations

Pin Configurations



Pin Configurations continued at end of data sheet.

µMAX is a registered trademark of Maxim Integrated Products, Inc.

Features

- **SO Package is Pin Compatible with TPS2014, TPS2015, and TPS2041**
- **Accurate Current Limit (0.7A min, 1.0A max)**
- **Guaranteed 0.75A Short-Circuit Protection**
- **10ms Internal $\overline{OC}$ Blanking Timeout**
- **No Overcurrent ($\overline{OC}$) Signal During Power-Up**
- **125mΩ max High-Side MOSFET**
- **500mA Continuous Current**
- **Short-Circuit and Thermal Protection with Overcurrent Logic Output**
- **1ms Start-Up Time**
- **Undervoltage Lockout**
- **14µA Quiescent Supply Current**
- **1µA max Standby Supply Current**
- **+2.7V to +5.5V Supply Range**
- **UL Recognized #E211935**

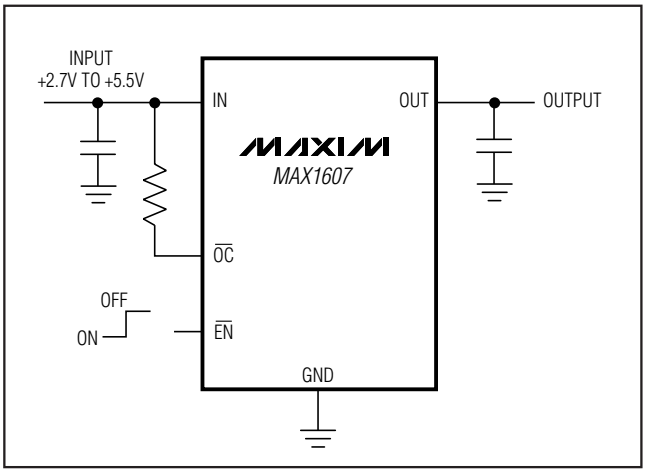
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX1607ESA	-40°C to +85°C	8 SO	S8-5
MAX1607ETB+	-40°C to +85°C	10 TDFN-EP*	T1033-1

**EP = Exposed paddle.*

+Denotes a lead-free package.

Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

USB Current-Limited Switch in Pin-Compatible Package

ABSOLUTE MAXIMUM RATINGS

IN, $\overline{EN}$, $\overline{OC}$ to GND .....-0.3 to +6V
OUT to GND .....-0.3V to (V_{IN} + 0.3V)
Maximum Switch Current.....1.2A (internally limited)
OUT Short-Circuit to GND .....Continuous

Continuous Power Dissipation (T_A = +70°C)
8-Pin SO (derate 5.88mW/°C above +70°C).....471mW
10-Pin TDFN (derate 18.5mW/°C above +70°C) 1481mW
Operating Temperature Range (extended).....-40°C to +85°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{IN} = +5V, **T_A = 0°C to +85°C,** unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
OPERATING CONDITION							
Input Voltage	V_{IN}			2.7		5.5	V
POWER SWITCH							
Switch Static Drain-Source On-State Resistance	$R_{DS(ON)}$	T_A = +25°C	V_{IN} = 4.4V to 5.5V		60	90	mΩ
		T_A = 0°C to +85°C	V_{IN} = 4.4V to 5.5V			125	
			V_{IN} = 3V		72	150	
Switch Turn-On Time	t_{ON}	I_{LOAD} = 400mA			80	200	µs
Switch Turn-Off Time	t_{OFF}	I_{LOAD} = 400mA		3	6	20	µs
ENABLE INPUT ($\overline{EN}$)							
$\overline{EN}$ High-Level Input Voltage	V_{IH}	V_{IN} = 2.7V to 3.6V		2.0			V
		V_{IN} = 3.7V to 5.5V		2.4			
$\overline{EN}$ Low-Level Input Voltage	V_{IL}	V_{IN} = 2.7V to 5.5V				0.8	V
$\overline{EN}$ Input Current		$V_{\overline{EN}}$ = V_{IN} or GND		-1		+1	µA
Start-Up Time		V_{IN} = 5V, C_{OUT} = 150µF from $\overline{EN}$ driven low to 50% full V_{OUT}			1		ms
CURRENT LIMIT							
Overload Output Current	I_{LIMIT}	Force V_{OUT} to 4.5V		700	850	1000	mA
Short-Circuit Output Current	I_{SC}	OUT shorted to GND			500	700	mA
SUPPLY CURRENT							
Supply Current, Low-Level Input		$V_{\overline{EN}}$ = V_{IN} = V_{OUT} = 5.5V			0.001	1	µA
Supply Current, High-Level Input	I_Q	$V_{\overline{EN}}$ = GND, I_{OUT} = 0	Timer not running		14	25	µA
			Timer running		35		
Supply Leakage Current		$V_{\overline{EN}}$ = V_{IN} = 5.5V, V_{OUT} = GND	T_A = +25°C		0.01	2	µA
			T_A = 0°C to +85°C			15	
UNDERVOLTAGE LOCKOUT							
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis		2.0	2.4	2.6	V
OVERCURRENT ($\overline{OC}$)							
$\overline{OC}$ Output Low Voltage	V_{OL}	I_{SINK} = 1mA, V_{IN} = 3V				0.4	V
$\overline{OC}$ Off-State Current		V_{IN} = $V_{\overline{OC}}$ = 5V				1	µA
$\overline{OC}$ Blanking Timeout Period	t_{BL}	From overcurrent condition to $\overline{OC}$ assertion		7	10	13	ms
THERMAL SHUTDOWN							
Thermal Shutdown Threshold					+165		°C

ELECTRICAL CHARACTERISTICS

(V_{IN} = +5V, **T_A = -40°C to +85°C,** unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OPERATING CONDITION						
Input Voltage	V_{IN}		3.0		5.5	V
POWER SWITCH						
Switch Static Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{IN} = 4.4V to 5.5V			125	mΩ
		V_{IN} = 3V			150	
Switch Turn-On Time	t_{ON}	I_{LOAD} = 400mA			200	µs
Switch Turn-Off Time	t_{OFF}	I_{LOAD} = 400mA	1		20	µs
ENABLE INPUT ($\overline{EN}$)						
$\overline{EN}$ High-Level Input Voltage	V_{IH}	V_{IN} = 3.0V to 3.6V	2.0			V
		V_{IN} = 3.7V to 5.5V	2.4			
$\overline{EN}$ Low-Level Input Voltage	V_{IL}	V_{IN} = 3.0V to 5.5V			0.8	V
$\overline{EN}$ Input Current		$V_{\overline{EN}}$ = V_{IN} or GND	-1		+1	µA
CURRENT LIMIT						
Overload Output Current	I_{LIMIT}	Force V_{OUT} to 4.5V	640		1060	mA
Short-Circuit Output Current	I_{SC}	OUT shorted to GND			750	mA
SUPPLY CURRENT						
Supply Current, Low-Level Input		$V_{\overline{EN}}$ = V_{IN} = V_{OUT} = 5.5V			2	µA
Supply Current, High-Level Input	I_Q	$V_{\overline{EN}}$ = GND, I_{OUT} = 0, timer not running			25	µA
Supply Leakage Current		$V_{\overline{EN}}$ = V_{IN} = 5.5V, V_{OUT} = GND			15	µA
UNDERVOLTAGE LOCKOUT						
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis	2.0		2.9	V
OVERCURRENT ($\overline{OC}$)						
$\overline{OC}$ Output Low Voltage	V_{OL}	I_{SINK} = 1mA, V_{IN} = 3V			0.4	V
$\overline{OC}$ Off-State Current		V_{IN} = $V_{\overline{OC}}$ = 5V			1	µA
$\overline{OC}$ Blanking Timeout Period	t_{BL}	From overcurrent condition to $\overline{OC}$ assertion	6		14	ms

Note 1: Specifications to -40°C are guaranteed by design, not production tested.

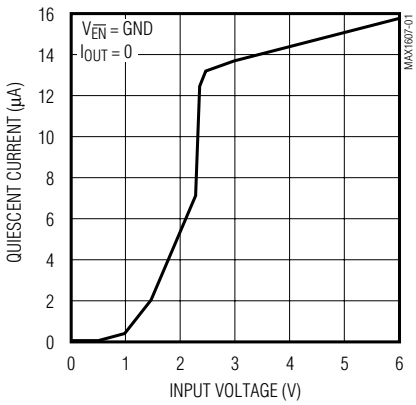
Note 2: TDFN package parts are 100% production tested at T_A = +25°C. Specifications over operating temperature are guaranteed by design.

USB Current-Limited Switch in Pin-Compatible Package

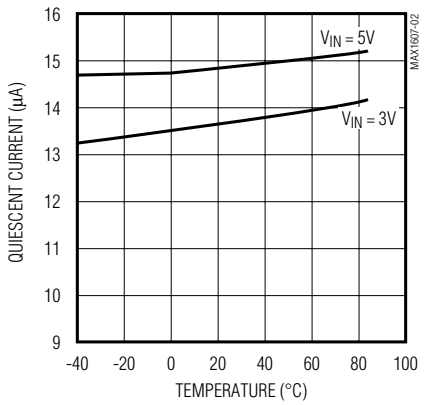
Typical Operating Characteristics

(V_{IN} = +5V, T_A = +25°C, unless otherwise noted.)

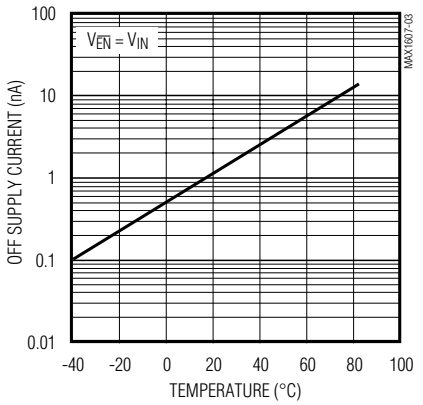
QUIESCENT CURRENT vs. INPUT VOLTAGE



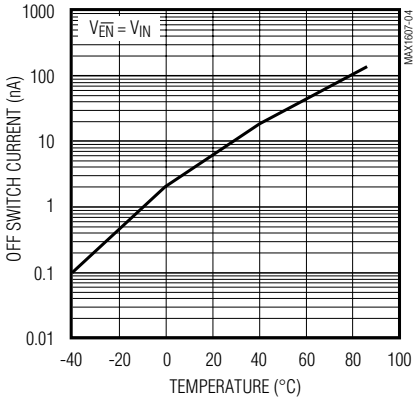
QUIESCENT CURRENT vs. TEMPERATURE



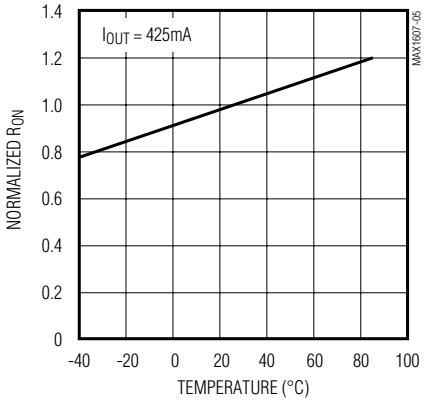
OFF SUPPLY CURRENT vs. TEMPERATURE



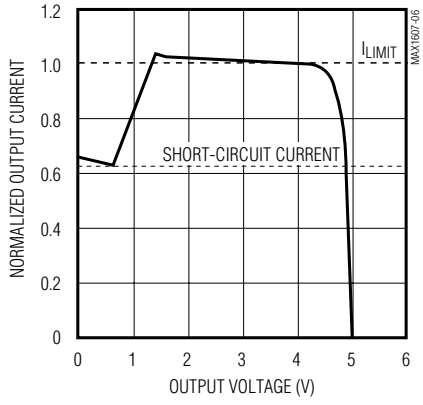
OFF SWITCH CURRENT vs. TEMPERATURE



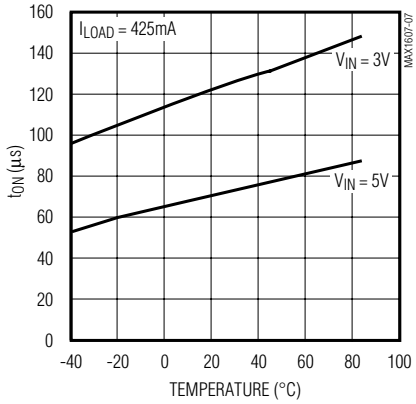
NORMALIZED ON-RESISTANCE vs. TEMPERATURE



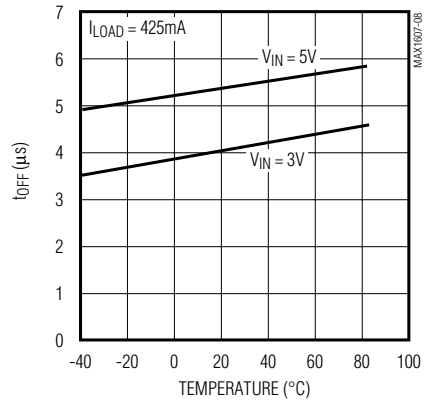
NORMALIZED OUTPUT CURRENT vs. OUTPUT VOLTAGE



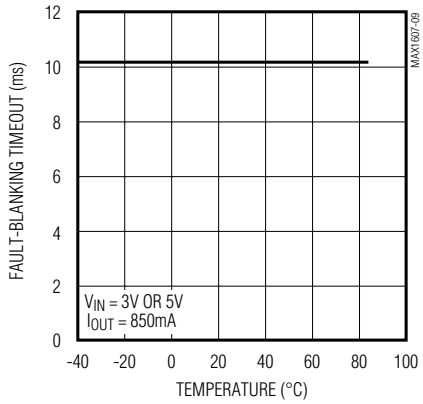
TURN-ON TIME vs. TEMPERATURE



TURN-OFF TIME vs. TEMPERATURE



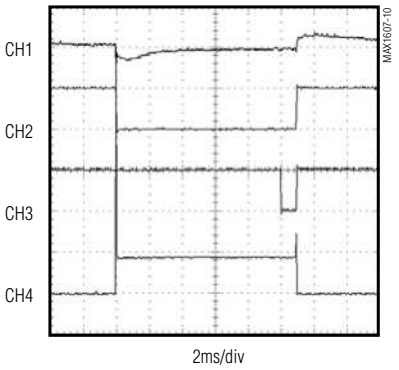
FAULT-BLANKING TIMEOUT vs. TEMPERATURE



Typical Operating Characteristics (continued)

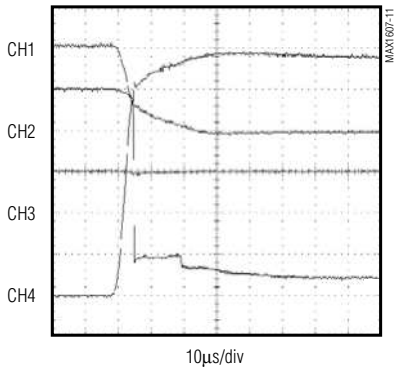
(V_{IN} = +5V, T_A = +25°C, unless otherwise noted.)

CURRENT-LIMIT AND $\overline{OC}$ RESPONSE



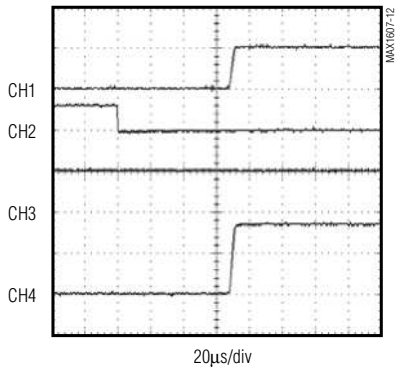
CH1 = V_{IN}, 200mV/div, AC-COUPLED
CH2 = V_{OUT}, 5V/div
CH3 = $V_{\overline{OC}}$, 5V/div
CH4 = I_{OUT}, 500mA/div

CURRENT-LIMIT RESPONSE



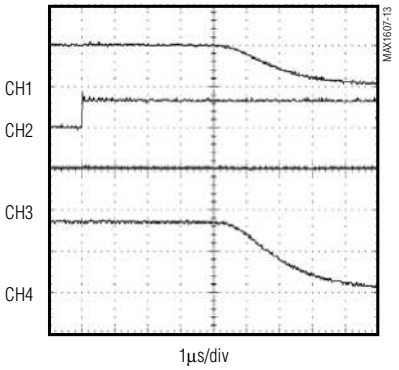
CH1 = V_{IN}, 200mV/div, AC-COUPLED
CH2 = V_{OUT}, 5V/div
CH3 = $V_{\overline{OC}}$, 5V/div
CH4 = I_{OUT}, 1A/div

SWITCH TURN-ON TIME



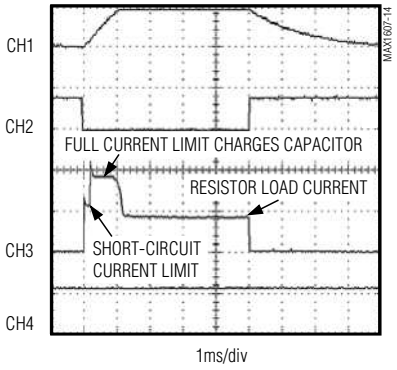
CH1 = V_{OUT}, 5V/div
CH2 = $V_{\overline{EN}}$, 5V/div
CH3 = $V_{\overline{OC}}$, 5V/div
CH4 = I_{OUT}, 200mA/div

SWITCH TURN-OFF TIME



CH1 = V_{OUT}, 5V/div
CH2 = $V_{\overline{EN}}$, 5V/div
CH3 = $V_{\overline{OC}}$, 5V/div
CH4 = I_{OUT}, 200mA/div

START-UP TIME (TYPICAL USB APPLICATION)



V_{IN} = 5V, R_L = 15Ω, C_L = 150µF
CH1 = V_{OUT}, 5V/div
CH2 = $V_{\overline{EN}}$, 5V/div
CH3 = I_{IN}, 500mA/div
CH4 = $V_{\overline{OC}}$, 5V/div

USB Current-Limited Switch in Pin-Compatible Package

Pin Description

PIN		NAME	FUNCTION
SO	TDFN		
1	6	GND	Ground
2, 3	1, 3, 9	IN	Input. P-channel MOSFET source. Connect all IN pins together and bypass with a 1µF capacitor to ground.
4	5	$\overline{EN}$	Active-Low Switch Enable Input. A logic-low turns on the switch.
5	7	$\overline{OC}$	Overcurrent Indicator Output. This open-drain output goes low when the device is in thermal shutdown or undervoltage lockout, or during a sustained (> 10ms) current-limit condition.
6, 7, 8	2, 4, 8, 10	OUT	Switch Output. P-channel MOSFET drain. Connect all OUT pins together and bypass with a 0.1µF capacitor to ground.
—	—	EP	Exposed Paddle (TDFN Package Only). Internally connected to GND. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point.

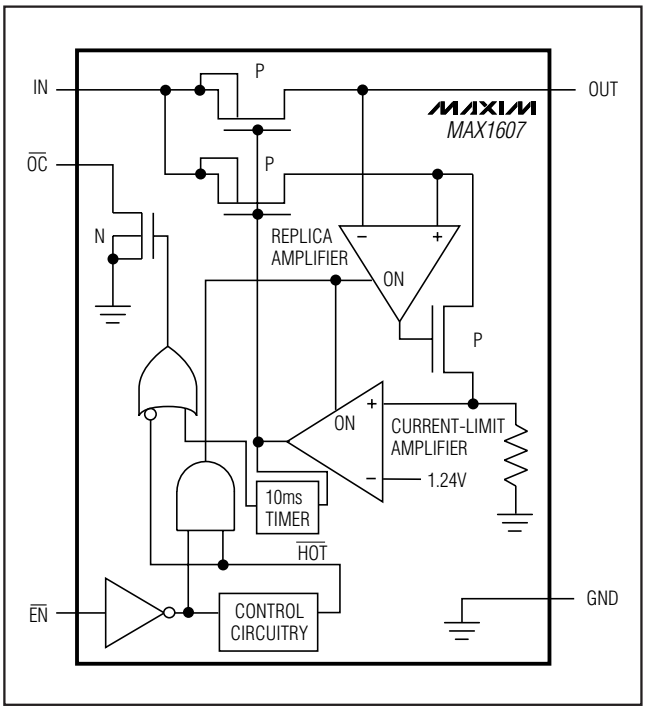


Figure 1. Functional Diagram

Detailed Description

The MAX1607 P-channel MOSFET power switch limits output current to 0.7A min and 1.0A max. When the output current is increased beyond the current limit (I_{LIMIT}), the current also increases through the replica switch (I_{OUT} / 6500). The current-limit error amplifier compares the voltage to the internal 1.24V reference and regulates the current back to the I_{LIMIT} (Figure 1).

These switches are not bidirectional; therefore, the input voltage must be higher than the output voltage.

Continuous Short-Circuit Protection

The MAX1607 is a short-circuit-protected switch. In the event of an output short-circuit condition, the current through the switch is foldback-current-limited to 500mA continuous.

Thermal Shutdown

The MAX1607 has a thermal shutdown feature. The switch turns off and the $\overline{OC}$ output goes low immediately (no overcurrent blanking) when the junction temperature exceeds +165°C. When the MAX1607 cools 20°C, the switch turns back on. If the fault short-circuit condition is not removed, the switch will cycle on and off, resulting in a pulsed output.

$\overline{OC}$ Indicator

The MAX1607 provides an overcurrent output ($\overline{OC}$). A 100kΩ pull-up resistor from $\overline{OC}$ to IN provides a logic control signal. This open-drain output goes low when any of the following conditions occur:

- The input voltage is below the 2.4V undervoltage-lockout (UVLO) threshold.
- The die temperature exceeds the thermal shutdown temperature limit of +165°C.
- The device is in current limit for greater than 10ms.

$\overline{OC}$ Blanking

The MAX1607 features 10ms overcurrent blanking. Blanking allows brief current-limit faults, including momentary short-circuit faults that occur when hot-swapping a capacitive load, and also ensures that no $\overline{OC}$ is issued during power-up. When a load transient causes the device to enter current limit, an internal

counter starts. If the load fault persists beyond the 10ms overcurrent-blanking timeout, the $\overline{OC}$ output asserts low. Ensure that the MAX1607 input is adequately bypassed to prevent input glitches from triggering spurious $\overline{OC}$ outputs. Input voltage glitches less than 150mV will not cause a spurious $\overline{OC}$ output. Load-transient faults less than 10ms (typ) will not cause an $\overline{OC}$ output assertion.

Only current-limit faults are blanked. Die overtemperature faults and input voltage droops below the UVLO threshold will cause an immediate $\overline{OC}$ output.

Applications Information

Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor from IN to GND. A 1µF ceramic capacitor will be adequate for most applications; however, higher capacitor values will further reduce the voltage drop at the input (Figure 2).

Output Capacitor

Connect a 0.1µF capacitor from OUT to GND. This capacitor helps to prevent inductive parasitics from pulling OUT negative during turn-off.

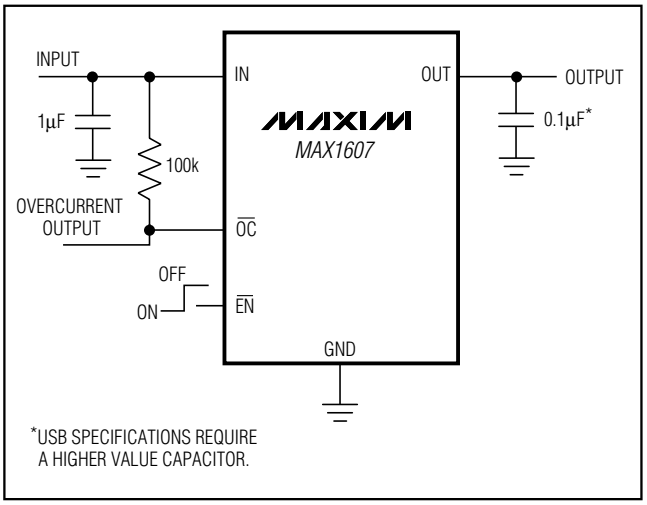


Figure 2. Typical Application Circuit

Layout and Thermal Dissipation

Important: Optimize the switch response time to output short-circuit conditions by keeping all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close as possible to the device (no more than 5mm away). All IN and OUT pins must be connected with short traces to the power bus. Wide power-bus planes will provide superior heat dissipation through the MAX1607's IN and OUT pins.

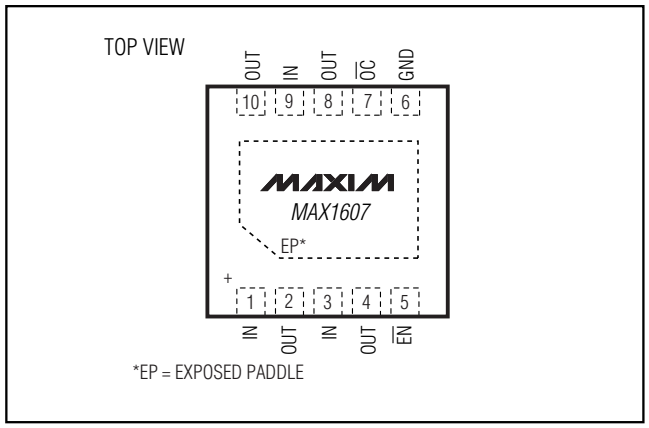
Under normal operating conditions, the package can dissipate and channel heat away. Calculate the maximum power dissipation as follows:

$$P = (I_{LIMIT})^2 \times R_{ON}$$

where I_{LIMIT} is the preset current limit (1.0A max) and R_{ON} is the on-resistance of the switch (125mΩ max).

When the output is short circuited, foldback-current limiting activates and the voltage drop across the switch equals the input supply. The power dissipated across the switch increases, as does the die temperature. If the fault condition is not removed, the thermal-overload-protection circuitry activates (see *Thermal Shutdown* section). Wide power-bus planes connected to IN and OUT and a ground plane in contact with the device will help dissipate additional heat.

Pin Configurations (continued)



Chip Information

TRANSISTOR COUNT: 715

USB Current-Limited Switch in Pin-Compatible Package

Package Information

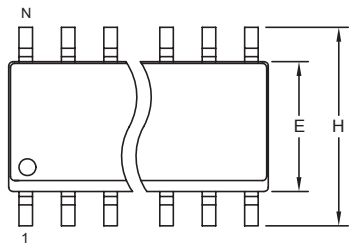
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

SOICN .EPS

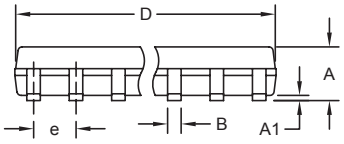
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050 BSC		1.27 BSC	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27

VARIATIONS:

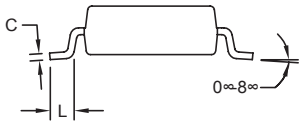
	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX	N	MS012
D	0.189	0.197	4.80	5.00	8	AA
D	0.337	0.344	8.55	8.75	14	AB
D	0.386	0.394	9.80	10.00	16	AC



TOP VIEW



FRONT VIEW



SIDE VIEW

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS012.
6. N = NUMBER OF PINS.

DALLAS SEMICONDUCTOR MAXIM

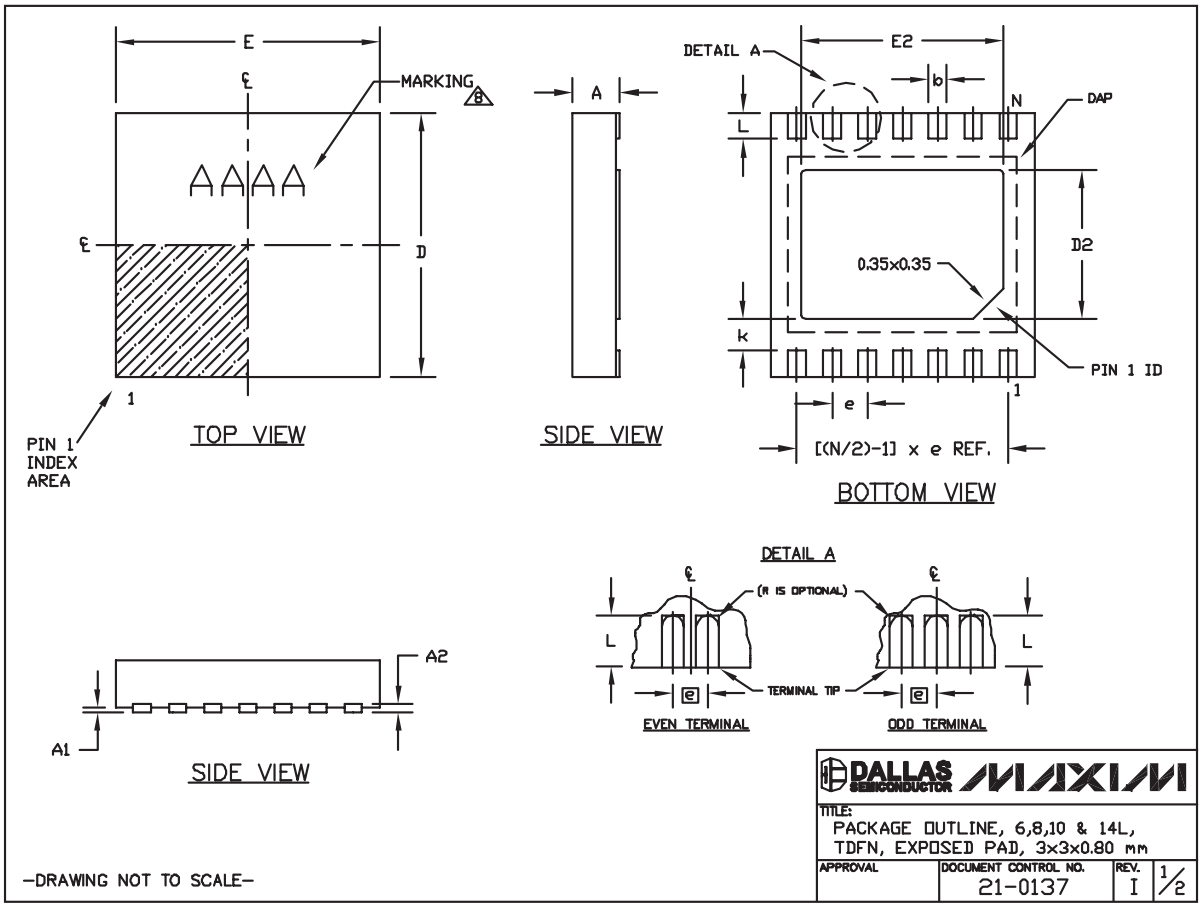
PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, .150" SOIC

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0041	B	1/1

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



USB Current-Limited Switch in Pin-Compatible Package

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	----	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	----	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. ⚠ MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	2/2

Revision History

Pages changed at Rev 2: 1, 2, 3, 6, 7–10

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